



Frequency Generator with 200MHz Differential CPU Clocks

Recommended Application:

CK-408 clock for Brookdale/Odem/Montara-GM for P4/Banias processor.

Output Features:

- 2 - Differential CPU Clock Pairs @ 3.3V
- 8 - PCI (3.3V) @ 33.3MHz including 2 1x/2x selectable PCI clocks
- 3 - PCI_F/PCI selectable (3.3V) @ 33.3MHz
- 1 - USB (3.3V) @ 48MHz, 1 DOT (3.3V) @ 48MHz
- 1 - REF (3.3V) @ 14.318MHz
- 4 - 3V66 (3.3V) @ 66.6MHz
- 1 - VCH/3V66 (3.3V) @ 48MHz or 66.6MHz

Features:

- Selectable 1X or 2X strength for REF and PCI via SMBus interface
- Programmable group to group skew
- Linear programmable frequency and spreading %
- Efficient power management scheme through PD#, CPU_STOP# and PCI_STOP#.
- Uses external 14.318MHz crystal
- Stop clocks and functional control available through SMBus interface.

Key Specifications:

- CPU Output Jitter <150ps
- 3V66 Output Jitter <250ps
- CPU Output Skew <100ps

Pin Configuration

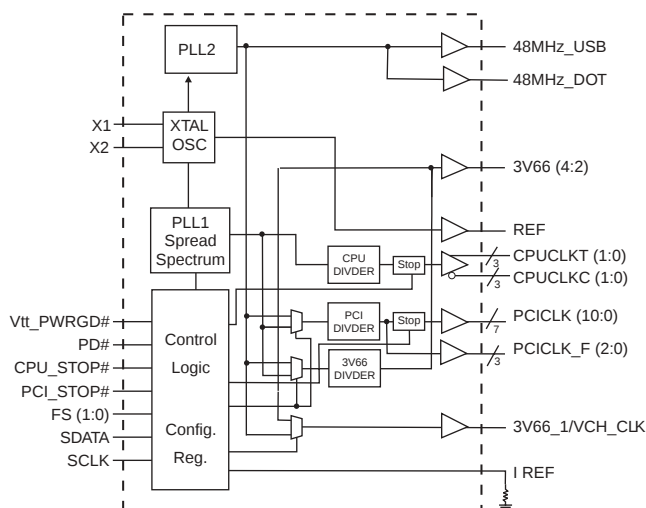
X1	1	48	VDDREF
X2	2	47	REF
GND	3	46	FS1
PCICLK_F0/PCICLK6	4	45	CPU_STOP#
PCICLK_F1/PCICLK7	5	44	VDDCPU
PCICLK_F2/PCICLK8	6	43	CPUCLKT0
GND	7	42	CPUCLKC0
PCICLK0	8	41	GND
PCICLK1	9	40	VDDCPU
*PCICLK2	10	39	CPUCLKT1
VDDPCI	11	38	CPUCLKC1
*PCICLK3	12	37	IREF
PCICLK4	13	36	FS0
PCICLK5	14	35	48MHz_USB
VDD3V66	15	34	48MHz_DOT
GND	16	33	VDD48
3V66_2	17	32	GND
3V66_3	18	31	3V66_1/VCH_CLK
3V66_4	19	30	PCI_STOP#
PCICLK9	20	29	PCICLK10
PD#	21	28	VDD3V66
VDDA	22	27	GND
GND	23	26	SCLK
Vtt_PWRGD#	24	25	SDATA

ICS950818

48-Pin 6.10 mm. Body, 0.50 mm. pitch TSSOP

*These outputs have selectable 1X/2X strength via SMBus

Block Diagram



Frequency Select Table 1

Freq Sel		CPU MHz	3V66(4:1) MHz	PCI MHz	REF MHz	USB/DOT MHz
FS 1	FS 0					
0	0	100.00	66.66	33.33	14.318	48.008
0	1	166.67	66.66	33.33	14.318	48.008
1	0	133.33	66.66	33.33	14.318	48.008
1	1	200.00	66.66	33.33	14.318	48.008



Pin Description

PIN #	PIN NAME	PIN TYPE	DESCRIPTION
1	X1	IN	Crystal input, Nominally 14.318MHz.
2	X2	OUT	Crystal output, Nominally 14.318MHz
3	GND	PWR	Ground pin.
4	PCICLK_F0/PCICLK6	OUT	Free running/Non-Free running PCI clock selected by SMBus.
5	PCICLK_F1/PCICLK7	OUT	Free running/Non-Free running PCI clock selected by SMBus.
6	PCICLK_F2/PCICLK8	OUT	Free running/Non-Free running PCI clock selected by SMBus.
7	GND	PWR	Ground pin.
8	PCICLK0	OUT	PCI clock output.
9	PCICLK1	OUT	PCI clock output.
10	*PCICLK2	OUT	PCI clock output.
11	VDDPCI	PWR	Power supply for PCI clocks, nominal 3.3V
12	*PCICLK3	I/O	PCI clock output.
13	PCICLK4	OUT	PCI clock output.
14	PCICLK5	OUT	PCI clock output.
15	VDD3V66	PWR	Power pin for the 3V66 clocks.
16	GND	PWR	Ground pin.
17	3V66_2	OUT	3.3V 66.66MHz clock output
18	3V66_3	OUT	3.3V 66.66MHz clock output
19	3V66_4	OUT	3.3V 66.66MHz clock output
20	PCICLK9	OUT	PCI clock output.
21	PD#	IN	Asynchronous active low input pin used to power down the device into a low power state. The internal clocks are disabled and the VCO and the crystal are stopped.
22	VDDA	PWR	3.3V power for the PLL core.
23	GND	PWR	Ground pin.
24	Vtt_PWRGD#	IN	This 3.3V LVTTTL input is a level sensitive strobe used to determine when latch inputs are valid and are ready to be sampled. This is an active low input.

**Pin Description (Continued)**

PIN #	PIN NAME	PIN TYPE	DESCRIPTION
25	SDATA	I/O	Data pin for I2C circuitry 5V tolerant
26	SCLK	IN	Clock pin of I2C circuitry 5V tolerant
27	GND	PWR	Ground pin.
28	VDD3V66	PWR	Power pin for the 3V66 clocks.
29	PCICLK10	OUT	PCI clock output.
30	PCI_STOP#	IN	Stops all PCICLKs besides the PCICLK_F clocks at logic 0 level, when input low
31	3V66_1/VCH_CLK	OUT	3.3V 66.66MHz clock output / 48MHz VCH clock output.
32	GND	PWR	Ground pin.
33	VDD48	PWR	Power pin for the 48MHz output.3.3V
34	48MHz_DOT	OUT	48MHz clock output.
35	48MHz_USB	OUT	48MHz clock output.
36	FS0	IN	Frequency select pin.
37	IREF	OUT	This pin establishes the reference current for the differential current-mode output pairs. This pin requires a fixed precision resistor tied to ground in order to establish the appropriate current. 475 ohms is the standard value.
38	CPUCLKC1	OUT	Complimentary clock of differential pair CPU outputs. These are current mode outputs. External resistors are required for voltage bias.
39	CPUCLKT1	OUT	True clock of differential pair CPU outputs. These are current mode outputs. External resistors are required for voltage bias.
40	VDDCPU	PWR	Supply for CPU clocks, 3.3V nominal
41	GND	PWR	Ground pin.
42	CPUCLKC0	OUT	Complimentary clock of differential pair CPU outputs. These are current mode outputs. External resistors are required for voltage bias.
43	CPUCLKT0	OUT	True clock of differential pair CPU outputs. These are current mode outputs. External resistors are required for voltage bias.
44	VDDCPU	PWR	Supply for CPU clocks, 3.3V nominal
45	CPU_STOP#	IN	Stops all CPUCLK besides the free running clocks
46	FS1	IN	Frequency select pin.
47	REF	OUT	14.318 MHz reference clock.
48	VDDREF	PWR	Ref, XTAL power supply, nominal 3.3V

Power Supply

Pin Number		Description
VDD	GND	
48	3	Xtal, Ref
11	7	PCICLK outputs
15, 28	16, 27	3V66
22	23	Master clock, CPU Analog
33	32	48MHz, Fix Digital, Fix Analog
	41	Inputs
40, 44	41	CPUCLK clocks



Default Setup of Byte 11-17

CPU (MHz)	SS%	Bytes						
		11	12	13	14	15	16	17
100.00	0	8E	B7	F8	17	94	95	0F
100.00	0 to -0.5%	8D	9A	F2	17	94	95	0F
100.00	0 to -1%	90	ED	EE	17	94	95	0F
100.00	+/- 0.25%	8E	B7	0A	18	94	95	0F
100.00	+/- 0.50%	8E	B7	06	18	94	95	0F
100.00	+/- 1.0%	8E	B7	15	18	94	95	0F

CPU (MHz)	SS%	Bytes						
		11	12	13	14	15	16	17
166.66	0	87	9B	F8	27	A4	A6	0F
166.66	0 to -0.5%	87	9A	EE	27	A4	A6	0F
166.66	0 to -1%	86	6B	E5	27	A4	A6	0F
166.66	+/- 0.25%	87	9B	15	28	A4	A6	0F
166.66	+/- 0.50%	87	9B	10	28	A4	A6	0F
166.66	+/- 1.0%	87	9B	28	28	A4	A6	0F

CPU (MHz)	SS%	Bytes						
		11	12	13	14	15	16	17
133.33	0	86	22	F9	1F	C4	C8	0F
133.33	0 to -0.5%	8B	DB	F0	1F	C4	C8	0F
133.33	0 to -1%	87	46	EB	1F	C4	C8	0F
133.33	+/- 0.25%	86	22	10	20	C4	C8	0F
133.33	+/- 0.50%	86	22	0C	20	C4	C8	0F
133.33	+/- 1.0%	86	22	1F	20	C4	C8	0F

CPU (MHz)	SS%	Bytes						
		11	12	13	14	15	16	17
200.00	0	86	B7	FB	2F	D4	D9	0F
200.00	0 to -0.5%	86	B6	F0	2F	D4	D9	0F
200.00	0 to -1%	84	46	E4	2F	D4	D9	0F
200.00	+/- 0.25%	86	B7	1D	30	D4	D9	0F
200.00	+/- 0.50%	86	B7	17	30	D4	D9	0F
200.00	+/- 1.0%	86	B7	34	30	D4	D9	0F



BYTE 0	Affected Pin		Control Function	Type	Bit Control		PWD
	Pin #	Name			0	1	
Bit 7	-	Spread Enabled	Spread Spectrum Control	RW	OFF	ON	0
Bit 6	-	CPUCLKT(1:0)	Power down mode output level 0= CPU driven in power down 1= undriven	RW	x2 IREF	Hi-Z	0
Bit 5	31	3V66_1/VCH_CLK	VCH/66.66 Select	RW	66.66	48.00	0
Bit 4	44	CPU_STOP#	Reflects value of pin	R	Stop	Active	X
Bit 3	30	PCI_STOP#	Reflects value of pin at power up. Also can be set.	RW	Stop	Active	X
Bit 2	-	-	(Reserved)	R	-	-	X
Bit 1	46	FS1	Frequency Selection	R	-	-	X
Bit 0	36	FS0	Frequency Selection	R	-	-	X

Note: For PCI_STOP# function, refer to table 2.

BYTE 1	Affected Pin		Control Function	Type	Bit Control		PWD
	Pin #	Name			0	1	
Bit 7	-	-	(Reserved)	R	-	-	X
Bit 6	-	CPUCLKT(1:0)	CPU_Stop mode output level 0= CPU driven when stopped 1 = undriven	RW	x2 IREF	Hi-Z	0
Bit 5	39, 38	CPUCLKT1, CPUCLKC1 (see note)	Allow control of output with assertion of CPU_STOP#.	RW	Not Freerun	Freerun	0
Bit 4	43, 42	CPUCLKT0, CPUCLKC0 (see note)	Allow control of output with assertion of CPU_STOP#.	RW	Not Freerun	Freerun	0
Bit 3	-	-	(Reserved)	R	-	-	X
Bit 2	39, 38	CPUCLKT1, CPUCLKC1	Output control	RW	Disable	Enable	1
Bit 1	43, 42	CPUCLKT0, CPUCLKC0	Output control	RW	Disable	Enable	1
Bit 0	-	-	(Reserved)	R	-	-	X

Note: CPUCLK(1:0) can be turned on/off by CPU_STOP#. Refer to table 3.

BYTE 2	Affected Pin		Control Function	Type	Bit Control		PWD
	Pin #	Name			0	1	
Bit 7	47	REF	1X or 0.5X Strength control	RW	1X	0.5X	0
Bit 6	14	PCICLK5	Output control	RW	Disable	Enable	1
Bit 5	13	PCICLK4	Output control	RW	Disable	Enable	1
Bit 4	12	*PCICLK3	Output control	RW	Disable	Enable	1
Bit 3	-	-	Reserved	X	-	-	1
Bit 2	10	*PCICLK2	Output control	RW	Disable	Enable	1
Bit 1	9	PCICLK1	Output control	RW	Disable	Enable	1
Bit 0	8	PCICLK0	Output control	RW	Disable	Enable	1

Note: PCICLK(5:0) can be turned on/off by PCI_STOP#. Refer to table 2.



BYTE 3	Affected Pin		Control Function	Type	Bit Control		PWD
	Pin #	Name			0	1	
Bit 7	34	48MHz_DOT	Output control	RW	Disable	Enable	1
Bit 6	35	48MHz_USB	Output control	RW	Disable	Enable	1
Bit 5	6	PCICLK_F2/PCICLK8 (see note)	Allow control of output with assertion of PCI_STOP#.	RW	Freerun	Not Freerun	0
Bit 4	5	PCICLK_F1/PCICLK7 (see note)	Allow control of output with assertion of PCI_STOP#.	RW	Freerun	Not Freerun	0
Bit 3	4	PCICLK_F0/PCICLK6 (see note)	Allow control of output with assertion of PCI_STOP#.	RW	Freerun	Not Freerun	0
Bit 2	6	PCICLK_F2/PCICLK8	Output control	RW	Disable	Enable	1
Bit 1	5	PCICLK_F1/PCICLK7	Output control	RW	Disable	Enable	1
Bit 0	4	PCICLK_F0/PCICLK6	Output control	RW	Disable	Enable	1

Note: PCICLK_F(2:0) can be turned on/off by PCI_STOP#. Refer to table 4.

BYTE 4	Affected Pin		Control Function	Type	Bit Control		PWD
	Pin #	Name			0	1	
Bit 7	10	*PCICLK2	Output strength (1X/2X)	R/W	2X	1X	1
Bit 6	12	*PCICLK3	Output strength (1X/2X)	R/W	2X	1X	1
Bit 5	29	PCICLK10	Output control	RW	Disable	Enable	1
Bit 4	31	3V66_1/VCH_CLK	Output control	RW	Disable	Enable	1
Bit 3	20	PCICLK9	Output control	RW	Disable	Enable	1
Bit 2	19	3V66_4	Output control	RW	Disable	Enable	1
Bit 1	18	3V66_3	Output control	RW	Disable	Enable	1
Bit 0	17	3V66_2	Output control	RW	Disable	Enable	1

BYTE 5	Affected Pin		Control Function	Type	Bit Control		PWD
	Pin #	Name			0	1	
Bit 7	X	PD Mode Iref Mirror Enable	Allow Iref Mirror to be ON during Power Down Mode	RW	OFF	ON	0
Bit 6	X	Reserved	Reserved	X	-	-	0
Bit 5	X	3V66(4:2) (See table 6)	Allow control of output with assertion of CPU_STOP#.	X	Freerun	Not Freerun	0
Bit 4	X	3V66(1) (See table 7)	Allow control of output with assertion of CPU_STOP#.	X	Freerun	Not Freerun	0
Bit 3	34	48MHz_DOT Slew Control	00 = Medium (default), 01 = Low, 11,10 =High	RW	-	-	0
Bit 2				RW	-	-	0
Bit 1	35	48MHz_USB Slew Control	00 = Medium (default), 01 = Low, 11,10 =High	RW	-	-	0
Bit 0				RW	-	-	0

Note: Functions in Byte 5 of CK408 were intended as a test and debug byte only.



BYTE 6	Affected Pin		Control Function	Type	Bit Control		PWD
	Pin #	Name			0	1	
Bit 7	X	Revision ID Bit 3	Revision ID Value Based on Device Revision	R	-	-	0
Bit 6	X	Revision ID Bit 2		R	-	-	0
Bit 5	X	Revision ID Bit 1		R	-	-	0
Bit 4	X	Revision ID Bit 0		R	-	-	0
Bit 3	X	Vendor ID Bit 3	(Reserved)	R	-	-	0
Bit 2	X	Vendor ID Bit 2	(Reserved)	R	-	-	0
Bit 1	X	Vendor ID Bit 1	(Reserved)	R	-	-	0
Bit 0	X	Vendor ID Bit 0	(Reserved)	R	-	-	1

BYTE 7	Affected Pin		Control Function	Type	Bit Control		PWD
	Pin #	Name			0	1	
Bit 7	X	-	(Reserved)	X	-	-	0
Bit 6	X	-	(Reserved)	X	-	-	0
Bit 5	X	-	(Reserved)	X	-	-	0
Bit 4	X	-	(Reserved)	X	-	-	0
Bit 3	X	-	(Reserved)	X	-	-	1
Bit 2	X	-	(Reserved)	X	-	-	1
Bit 1	X	-	(Reserved)	X	-	-	1
Bit 0	X	-	(Reserved)	X	-	-	0

BYTE 8	Affected Pin		Control Function	Type	Bit Control		PWD
	Pin #	Name			0	1	
Bit 7	X	-	(Reserved)	X	-	-	0
Bit 6	X	-	(Reserved)	X	-	-	0
Bit 5	X	-	(Reserved)	X	-	-	0
Bit 4	X	-	(Reserved)	X	-	-	0
Bit 3	X	-	Readback Byte Count	R	-	-	1
Bit 2	X	-		R	-	-	1
Bit 1	X	-		R	-	-	1
Bit 0	X	-		R	-	-	1

Note: Byte 8 is for ICS test only. Do not write as system damage may occur. Bit(3:0) contain the readback Byte count.

BYTE 9	Affected Pin		Control Function	Type	Bit Control		PWD
	Pin #	Name			0	1	
Bit 7	X	-	(Reserved)	X	-	-	0
Bit 6	X	-	(Reserved)	X	-	-	0
Bit 5	X	-	(Reserved)	X	-	-	0
Bit 4	X	-	(Reserved)	X	-	-	0
Bit 3	X	-	(Reserved)	X	-	-	0
Bit 2	X	-	(Reserved)	X	-	-	0
Bit 1	X	-	(Reserved)	X	-	-	0
Bit 0	X	-	(Reserved)	X	-	-	0



BYTE 10	Affected Pin		Control Function	Type	Bit Control		PWD
	Pin #	Name			0	1	
Bit 7	X	-	M/N Enable (Enable access to Byte 11 - 14)	RW	HW/B0	Byte (11-14)	0
Bit 6	X	-	(Reserved)	X	-	-	0
Bit 5	X	-	(Reserved)	X	-	-	1
Bit 4	X	-	(Reserved)	X	-	-	1
Bit 3	X	-	(Reserved)	X	-	-	1
Bit 2	X	-	(Reserved)	X	-	-	1
Bit 1	X	-	(Reserved)	X	-	-	1
Bit 0	X	-	(Reserved)	X	-	-	0

BYTE 11	Affected Pin		Control Function	Type	Bit Control		PWD
	Pin #	Name			0	1	
Bit 7	X	-	VCO Divider Bit8	RW	-	-	X
Bit 6	X	-	REF Divider Bit6	RW	-	-	X
Bit 5	X	-	REF Divider Bit5	RW	-	-	X
Bit 4	X	-	REF Divider Bit4	RW	-	-	X
Bit 3	X	-	REF Divider Bit3	RW	-	-	X
Bit 2	X	-	REF Divider Bit2	RW	-	-	X
Bit 1	X	-	REF Divider Bit1	RW	-	-	X
Bit 0	X	-	REF Divider Bit0	RW	-	-	X

Note: The decimal representation of these 7 bits (Byte 11 bit[6:0]) + 2 is equal to the REF divider value.

BYTE 12	Affected Pin		Control Function	Type	Bit Control		PWD
	Pin #	Name			0	1	
Bit 7	X	-	VCO Divider Bit7	RW	-	-	X
Bit 6	X	-	VCO Divider Bit6	RW	-	-	X
Bit 5	X	-	VCO Divider Bit5	RW	-	-	X
Bit 4	X	-	VCO Divider Bit4	RW	-	-	X
Bit 3	X	-	VCO Divider Bit3	RW	-	-	X
Bit 2	X	-	VCO Divider Bit2	RW	-	-	X
Bit 1	X	-	VCO Divider Bit1	RW	-	-	X
Bit 0	X	-	VCO Divider Bit0	RW	-	-	X

Note: The decimal representation of these 9 bits (Byte 12 bit[7:0]) and Byte 11 bit [7] + 8 is equal to the VCO divider value.

BYTE 13	Affected Pin		Control Function	Type	Bit Control		PWD
	Pin #	Name			0	1	
Bit 7	X	-	Spread Spectrum Bit7	RW	-	-	X
Bit 6	X	-	Spread Spectrum Bit6	RW	-	-	X
Bit 5	X	-	Spread Spectrum Bit5	RW	-	-	X
Bit 4	X	-	Spread Spectrum Bit4	RW	-	-	X
Bit 3	X	-	Spread Spectrum Bit3	RW	-	-	X
Bit 2	X	-	Spread Spectrum Bit2	RW	-	-	X
Bit 1	X	-	Spread Spectrum Bit1	RW	-	-	X
Bit 0	X	-	Spread Spectrum Bit0	RW	-	-	X

Note: Please utilize software utility provided by ICS Application Engineering to configure spread spectrum. Incorrect spread percentage may cause system failure.



BYTE 14	Affected Pin		Control Function	Type	Bit Control		PWD
	Pin #	Name			0	1	
Bit 7	X	-	(Reserved)	RW	-	-	X
Bit 6	X	-	(Reserved)	RW	-	-	X
Bit 5	X	-	Spread Spectrum Bit13	RW	-	-	X
Bit 4	X	-	Spread Spectrum Bit12	RW	-	-	X
Bit 3	X	-	Spread Spectrum Bit11	RW	-	-	X
Bit 2	X	-	Spread Spectrum Bit10	RW	-	-	X
Bit 1	X	-	Spread Spectrum Bit9	RW	-	-	X
Bit 0	X	-	Spread Spectrum Bit8	RW	-	-	X

Note: Please utilize software utility provided by ICS Application Engineering to configure spread spectrum. Incorrect spread percentage may cause system failure.



Table 2

PCI_STOP# SMBus Control Table-Byte 0, Bit 3

PCI_STOP# (Pin 30)	Byte 0 Bit 3 Write Bit	Byte 0, Bit 3 Read Bit (Internal Status)
0	0	0
0	1	0
1	0	0
1	1	1

Note: When this Byte 0, Bit 3 is low (0), all PCI clocks are stopped.

Table 3

CPUCLKT/C (1:0) Outputs SMBus Control Table

CPU_STOP# (Pin 45)	Byte 1 Bit 4, 5	CPUCLKT/C (1:0) Outputs
0	0	Stop
0	1	Running
1	0	Running
1	1	Running

Note: Individual CPUCLK outputs are controlled by Byte 1, Bit 4, and 5.

Table 4

PCICLK_F (2:0) Outputs SMBus Control Table

PCI_STOP# (Pin 30)	Byte 3 Bit 3, 4, 5	PCICLK (2:0) Outputs
0	0	Stop
0	1	Running
1	0	Running
1	1	Running

Note: Individual PCICLK outputs are controlled by Byte 3, Bit 3, 4, and 5.

Table 5

3V66 (4:2) SMBus Control Table

CPU_STOP# (Pin 45)	Byte 5 Bit 5	3V66 (4:2)
0	0	Running
0	1	Stopped
1	0	Running
1	1	Running

Note: Activating Byte 5, Bit 5 will allow CPU_STOP# to control stop of pins 17, 18, and 19

Table 6

3V66 (1) SMBus Control Table

CPU_STOP# (Pin 45)	Byte 5 Bit 4	3V66 (1)
0	0	Running
0	1	Stopped
1	0	Running
1	1	Running

Note: Activating Byte 5, Bit 4 will allow CPU_STOP# to control stop of pins 31.



Absolute Maximum Ratings

Supply Voltage	5.5 V
Logic Inputs	GND –0.5 V to $V_{DD} + 0.5$ V
Ambient Operating Temperature	0°C to +90°C
Case Temperature	115°C
Storage Temperature	–65°C to +150°C

Stresses above those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These ratings are stress specifications only and functional operation of the device at these or any other conditions above those listed in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

Electrical Characteristics - Input/Supply/Common Output Parameters

$T_A = 0 - 90^\circ\text{C}$; Supply Voltage $V_{DD} = 3.3$ V $\pm 5\%$

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Input High Voltage	V_{IH}		2		$V_{DD}+0.3$	V
Input Low Voltage	V_{IL}		$V_{SS}-0.3$		0.8	V
Input High Current	I_{IH}	$V_{IN} = V_{DD}$; Inputs with no pull-down resistors			5.75	mA
	I_{IH}	$V_{IN} = V_{DD}$; Inputs with pull-down resistors			200	μA
Input Low Current	I_{IL1}	$V_{IN} = 0$ V; Inputs with no pull-up resistors	-5.75			mA
	I_{IL2}	$V_{IN} = 0$ V; Inputs with pull-up resistors	-200			μA
Operating Supply Current	$I_{DD3.30P}$	$C_L = \text{Full load}$; Select @ 100 MHz		182	280	mA
	$I_{DD3.30P}$	$C_L = \text{Full load}$; Select @ 133 MHz		189	280	mA
Powerdown Current	$I_{DD3.3PD}$	$I_{REF}=5$ mA		14	52	mA
	$I_{DD3.3PDHIZ}$			9	0.5	mA
Input Frequency	F_i	$V_{DD} = 3.3$ V		14.32		MHz
Pin Inductance	L_{pin}				7	nH
Input Capacitance ¹	C_{IN}	Logic Inputs			5	pF
	C_{OUT}	Output pin capacitance			6	pF
	C_{INX}	X1 & X2 pins	27		45	pF
Clk Stabilization ^{1,2}	T_{STAB}	From PowerUp or deassertion of PowerDown to 1st clock.			2.1	ms
Delay ¹	t_{PZH}, t_{PZL}	Output enable delay (all outputs)	1		12	ns
	t_{PHZ}, t_{PLZ}	Output disable delay (all outputs)	1		12	ns

¹Guaranteed by design, not 100% tested in production.

²See timing diagrams for buffered and un-buffered timing requirements.

**Electrical Characteristics - CPU (0.7V Select) 100MHz**T_A = 0 - 90°C; VDD=3.3V +/-5%; C_L = 10-20 pF (unless otherwise specified)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Current Source Output Impedance	Z _O ¹	V _O = V _x	3000	-		Ω
Average Period	T _{PERIOD}	Fig. 1	10.00	10.02	10.20	ns
Voltage High	V _{HIGH}	Statistical measurement on single ended signal using oscilloscope math function.	660	757.1	850	mV
Voltage Low	V _{LOW}		-150	9.067	150	
Max Voltage	V _{OVs}	Measurement on single ended signal using absolute value.		774.7	1150	mV
Min Voltage	V _{UDs}		-450	3		
Crossing Voltage (abs)	V _{CROSS(ABS)}	Fig. 3	250	386.1	550	mV
Crossing Voltage (var)	d-V _{CROSS}	Variation of crossing over all edges (Fig. 4)		41.57	140	mV
Rise Time	t _r	V _{OL} = 0.175V, V _{OH} = 0.525V (Fig. 3)	175	552.8	810	ps
Fall Time	t _f	V _{OH} = 0.525V V _{OL} = 0.175V (Fig. 3)	175	558.7	810	ps
Rise Time Variation	d-t _r			34.25	125	ps
Fall Time Variation	d-t _f			45.5	125	ps
Duty Cycle	d _{t3}	Measurement from differential waveform (Fig 1)	45	50.58	55	%
Skew	t _{SK3}	V _T = 50%		60.5	100	ps
Jitter, Cycle to cycle	t _{JCYC-CYC} ¹	V _T = 50% (Fig. 1)		65.25	175	ps

¹Guaranteed by design, not 100% tested in production.**Electrical Characteristics - CPU (0.7V Select) 133.33MHz**T_A = 0 - 90°C; VDD=3.3V +/-5%; C_L = 10-20 pF (unless otherwise specified)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Current Source Output Impedance	Z _O ¹	V _O = V _x	3000	-		Ω
Average Period	T _{PERIOD}	Fig. 1	7.50	7.58	7.65	ns
Voltage High	V _{HIGH}	Statistical measurement on single ended signal using oscilloscope math function.	660	757	850	mV
Voltage Low	V _{LOW}		-150	9	150	
Max Voltage	V _{OVs}	Measurement on single ended signal using absolute value.		775	1150	mV
Min Voltage	V _{UDs}		-450	3		
Crossing Voltage (abs)	V _{CROSS(ABS)}	Fig. 3	250	386	550	mV
Crossing Voltage (var)	d-V _{CROSS}	Variation of crossing over all edges (Fig. 4)		42	140	mV
Rise Time	t _r	V _{OL} = 0.175V, V _{OH} = 0.525V (Fig. 3)	175	553	810	ps
Fall Time	t _f	V _{OH} = 0.525V V _{OL} = 0.175V (Fig. 3)	175	559	810	ps
Rise Time Variation	d-t _r			34	125	ps
Fall Time Variation	d-t _f			46	125	ps
Duty Cycle	d _{t3}	Measurement from differential waveform (Fig 1)	45	51	55	%
Skew	t _{SK3}	V _T = 50%		61	100	ps
Jitter, Cycle to cycle	t _{JCYC-CYC} ¹	V _T = 50% (Fig. 1)		65	175	ps

¹Guaranteed by design, not 100% tested in production.

**Electrical Characteristics - 3V66**T_A = 0 - 90°C; VDD=3.3V +/-5%; C_L = 10-30 pF (unless otherwise specified)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output Impedance	R _{DSP1} ¹	V _O = V _{DD} *(0.5)	12	64.50	65	Ω
Average Period	T _{PERIOD}	Fig. 8	15.00	15.01	15.30	ns
Output High Voltage	V _{OH} ¹	I _{OH} = -1 mA	2.05	3.24		V
Output Low Voltage	V _{OL} ¹	I _{OL} = 1 mA		0.06	0.65	V
Output High Current	I _{OH} ¹	V _{OH} = 1.0 V		-90	-33	mA
		V _{OH} = 3.135 V	-33	-14		
Output Low Current	I _{OL} ¹	V _{OL} = 1.95 V	26	35		
		V _{OL} = 0.4 V		103	38	
Rise Time	t _{r1} ¹	V _{OL} = 0.4 V, V _{OH} = 2.4 V (Fig. 7)	0.5	1.74	2.3	ns
Fall Time	t _{f1} ¹	V _{OH} = 2.4 V, V _{OL} = 0.4 V (Fig. 7)	0.5	1.45	2.3	ns
Duty Cycle	d _{t1} ¹	V _T = 1.5 V (Fig. 8)	45	52.05	55	%
Skew	t _{sk1} ¹	V _T = 1.5 V		13.50	250	ps
Jitter	t _{jvc-cvc} ¹	V _T = 1.5 V (Fig. 8)		158.75	290	ps

¹Guaranteed by design, not 100% tested in production.**Electrical Characteristics - VCH, 48MHz DOT, 48MHz, USB**T_A = 0 - 90°C; VDD=3.3V +/-5%; C_L = 10-20 pF (unless otherwise specified)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output Frequency	F _{O1}	Fig. 8		48.008		MHz
Output Impedance	R _{DSP1} ¹	V _O = V _{DD} *(0.5)	20	52.50	70	Ω
Output High Voltage	V _{OH} ¹	I _{OH} = -1 mA	2.05	3.24		V
Output Low Voltage	V _{OL} ¹	I _{OL} = 1 mA		0.06	0.5	V
Output High Current	I _{OH} ¹	V _{OH} = 1.0 V		-53	-29	mA
		V _{OH} = 3.135 V	-20	-7		
Output Low Current	I _{OL} ¹	V _{OL} = 0.4 V		21	27	mA
		V _{OL} 1.95 V	25	60		
48DOT Rise Time	t _{r1} ¹	V _{OL} = 0.4 V, V _{OH} = 2.4 V (Fig. 7)	0.5	0.86	1.15	ns
48DOT Fall Time	t _{f1} ¹	V _{OH} = 2.4 V, V _{OL} = 0.4 V (Fig. 7)	0.5	0.86	1.15	ns
VCH 48 USB Rise Time	t _{r1} ¹	V _{OL} = 0.4 V, V _{OH} = 2.4 V (Fig. 7)	1	1.37	2.3	ns
VCH 48 USB Fall Time	t _{f1} ¹	V _{OH} = 2.4 V, V _{OL} = 0.4 V (Fig. 7)	1	1.37	2.3	ns
48 DOT Duty Cycle	d _{t1} ¹	V _T = 1.5 V (Fig. 8)	45	51.10	55	%
VCH 48 USB Duty Cycle	d _{t1} ¹	V _T = 1.5 V (Fig. 8)	45	52.80	55	%
48 DOT Jitter	t _{jvc-cvc} ¹	V _T = 1.5 V (Fig. 8)		182.63	410	ps
USB to DOT Skew	t _{sk1} ¹	V _T = 1.5 V (0 OR 180 degrees)		0.13	1	ns
VCH Jitter	t _{jvc-cvc} ¹	V _T = 1.5 V (Fig. 8)		153.25	410	ps

¹Guaranteed by design, not 100% tested in production.

**Electrical Characteristics - PCICLK_F, PCICLK 1X**T_A = 0 - 90°C; VDD=3.3V +/-5%; C_L = 10-30 pF (unless otherwise specified)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output Impedance	R _{DSP1} ¹	V _O = V _{DD} *(0.5)	12	52.50	65	Ω
Average Period	T _{PERIOD}	Fig. 8	30.00	30.03		ns
Output High Voltage	V _{OH} ¹	I _{OH} = -1 mA	2.05	3.24		V
Output Low Voltage	V _{OL} ¹	I _{OL} = 1 mA		0.06	0.65	V
Output High Current	I _{OH} ¹	V _{OH} = 1.0 V		-90	-33	mA
		V _{OH} = 3.135 V	-33	-14		
Output Low Current	I _{OL} ¹	V _{OL} = 1.95 V	26	35		
		V _{OL} = 0.4 V		103	38	
Rise Time	t _{r1} ¹	V _{OL} = 0.4 V, V _{OH} = 2.4 V (Fig. 7)	0.5	1.79	2.3	ns
Fall Time	t _{f1} ¹	V _{OH} = 2.4 V, V _{OL} = 0.4 V (Fig. 7)	0.5	1.82	2.3	ns
Duty Cycle	d _{t1} ¹	V _T = 1.5 V (Fig. 8)	45	51.57	55	%
Skew	t _{sk1} ¹	V _T = 1.5 V		136.00	500	ps
Jitter,cycle to cyc	t _{jcyc-cyc} ¹	V _T = 1.5 V (Fig. 8)		151.5	290	ps

¹Guaranteed by design, not 100% tested in production.**Electrical Characteristics - PCICLK (3:2) 2X**T_A = 0 - 90°C; VDD=3.3V +/-5%; C_L = 10-30 pF (unless otherwise specified)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output Impedance	R _{DSP1} ¹	V _O = V _{DD} *(0.5)		52.5		Ω
Average Period	T _{PERIOD}	Fig. 8		30.03		ns
Output High Voltage	V _{OH} ¹	I _{OH} = -1 mA		3.24	2.7	V
Output Low Voltage	V _{OL} ¹	I _{OL} = 1 mA	0.4	0.06		V
Output High Current	I _{OH} ¹	V _{OH} = 1.0 V		-100	-60	mA
		V _{OH} = 3.135 V	-28	-17		
Output Low Current	I _{OL} ¹	V _{OL} = 1.95 V		44	60	
		V _{OL} = 0.4 V	26	100		
Rise Time	t _{r1} ¹	V _{OL} = 0.4 V, V _{OH} = 2.4 V (Fig. 7)	0.5	1.75	2.3	ns
Fall Time	t _{f1} ¹	V _{OH} = 2.4 V, V _{OL} = 0.4 V (Fig. 7)	0.5	1.80	2.3	ns
Duty Cycle	d _{t1} ¹	V _T = 1.5 V (Fig. 8)	45	51.95	55	%
Skew	t _{sk1} ¹	V _T = 1.5 V		136	500	ps
Jitter,cycle to cyc	t _{jcyc-cyc} ¹	V _T = 1.5 V (Fig. 8)		151.5	290	ps

¹Guaranteed by design, not 100% tested in production.

**Electrical Characteristics - REF (1X select)**T_A = 0 - 90°C; VDD=3.3V +/-5%; C_L = 10-20 pF (unless otherwise specified)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output Frequency	F _{O1}	Fig. 8		14.318		MHz
Output Impedance	R _{DSP1} ¹	V _O = V _{DD} *(0.5)	20	52.50	70	Ω
Output High Voltage	V _{OH} ¹	I _{OH} = -1 mA	2.05	3.24		V
Output Low Voltage	V _{OL} ¹	I _{OL} = 1 mA		0.06	0.45	V
Output High Current	I _{OH} ¹	V _{OH} = 1.0 V		-70	-29	mA
		V _{OH} = 3.135 V	-25	-12		
Output Low Current	I _{OL} ¹	V _{OL} = 0.4 V		30	38	
		V _{OL} 1.95 V	26	60		
Rise Time	t _{r1} ¹	V _{OL} = 0.4 V, V _{OH} = 2.4 V (Fig. 7)	1	-	2.3	ns
Fall Time	t _{f1} ¹	V _{OH} = 2.4 V, V _{OL} = 0.4 V (Fig. 7)	1	1.98	2.3	ns
Duty Cycle	d _{t1} ¹	V _T = 1.5 V	45	54.50	55	%
Jitter	t _{jcy-cyc} ¹	V _T = 1.5 V (Fig. 8)		242	1200	ps

¹Guaranteed by design, not 100% tested in production.**Electrical Characteristics - REF (2X select)**T_A = 0 - 90°C; VDD=3.3V +/-5%; C_L = 20-40 pF (unless otherwise specified)

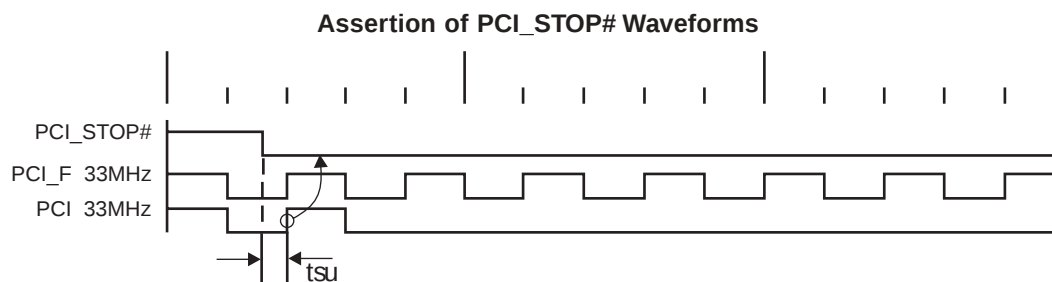
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output Frequency	F _{O1}	Fig. 8		14.318		MHz
Output Impedance	R _{DSP1} ¹	V _O = V _{DD} *(0.5)		52.5		Ω
Output High Voltage	V _{OH} ¹	I _{OH} = -1 mA	2.7	3.24		V
Output Low Voltage	V _{OL} ¹	I _{OL} = 1 mA		0.06	0.4	V
Output High Current	I _{OH} ¹	V _{OH} = 1.0 V		-100	-60	mA
		V _{OH} = 3.135 V	-28	-17		
Output Low Current	I _{OL} ¹	V _{OL} = 0.4 V		44	60	
		V _{OL} 1.95 V	26	100		
Rise Time	t _{r1} ¹	V _{OL} = 0.4 V, V _{OH} = 2.4 V (Fig. 7)	1	-	2.3	ns
Fall Time	t _{f1} ¹	V _{OH} = 2.4 V, V _{OL} = 0.4 V (Fig. 7)	1	1.98	2.3	ns
Duty Cycle	d _{t1} ¹	V _T = 1.5 V	45	54.70	55	%
Jitter	t _{jcy-cyc} ¹	V _T = 1.5 V (Fig. 8)		242	1200	ps

¹Guaranteed by design, not 100% tested in production.



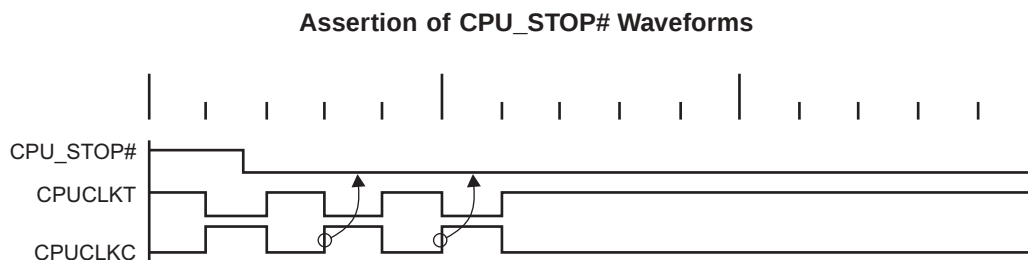
PCI_STOP# - Assertion (transition from logic "1" to logic "0")

The impact of asserting the PCI_STOP# signal will be the following. All PCI[10:0] and stoppable PCI_F clocks will latch low in their next high to low transition. The PCI_STOP# setup time t_{su} is 10 ns, for transitions to be recognized by the next rising edge.



CPU_STOP# - Assertion (transition from logic "1" to logic "0")

The impact of asserting the CPU_STOP# pin is all CPU outputs that are set in the SMBus configuration to be stoppable via assertion of CPU_STOP# are to be stopped after their next transition. When the SMBus Bit 6 of Byte 1 is programmed to '0' the final state of the stopped CPU signals is CPU = High and CPU# = Low. There is to be no change to the output drive current values. The CPU will be driven high with a current value equal to (Mult 0 'select') x (Iref), the CPU# signal will not be driven. When the SMBus Bit 6 of Byte 1 is programmed to '1' then final state of the stopped CPU signals is Low, both CPU and CPU# outputs will not be driven.



CPU_STOP# Functionality

CPU_STOP#	CPUT	CPUC
1	Normal	Normal
0	$i_{ref} * Mult$	Float

Group to Group Skews at Common Transition Edges: Unbuffered Mode

GROUP	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
3V66 to PCI ^{1,2}	S _{3V66-PCI}	3V66 (4:1) leads 33MHz PCI	1.5	2.765	3.5	ns

¹Guaranteed by design, not 100% tested in production.

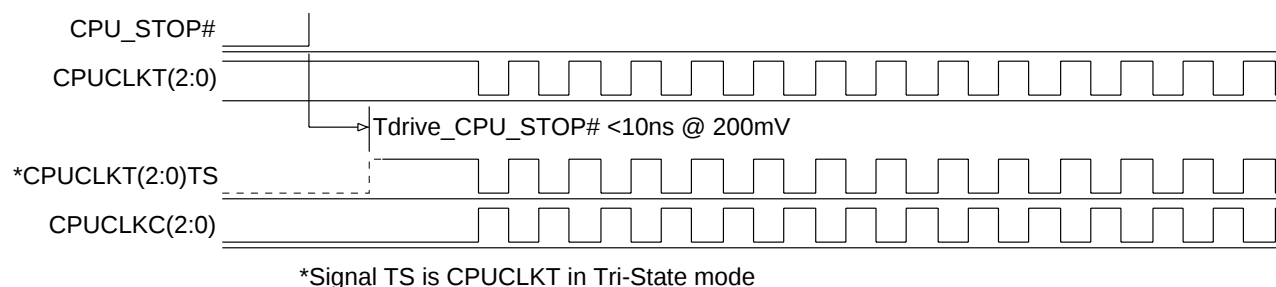
²500ps Tolerance



CPU_STOP# - De-assertion (transition from logic "0" to logic "1")

All CPU outputs that were stopped are to resume normal operation in a glitch free manner. The maximum latency from the de-assertion to active outputs is to be defined to be between 2 - 6 CPU clock periods (2 clocks are shown). If the SMBus Bit 6 of Byte 1 is programmed to "1" then the stopped CPU outputs will be driven High within 10 nS of CPU_Stop# de-assertion.

De-assertion of CPU_STOP# Waveforms

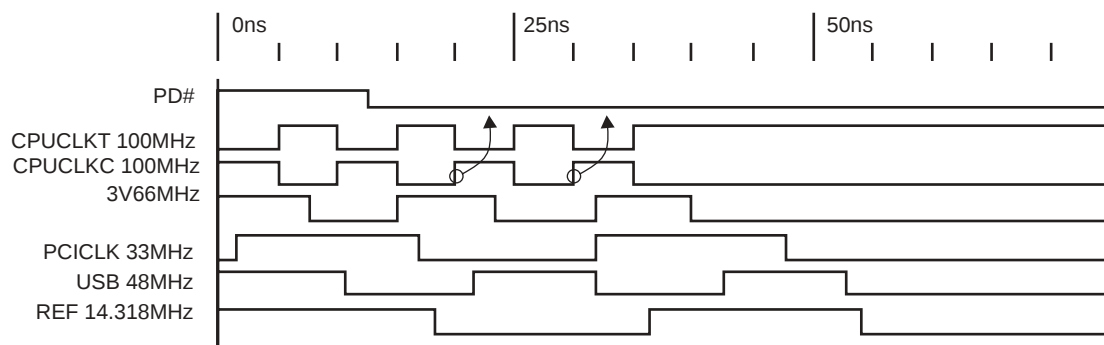


PD# - Assertion (transition from logic "1" to logic "0")

When PWRDWN# is sampled low by two consecutive rising edges of CPU clock, then all clock outputs except CPU clocks must be held low on their next high to low transitions. When the SMBUS Bit 6 of Byte 0 is programmed to '0' CPU clocks must be held with the CPU clock pin driven high with a value of $2 \times I_{ref}$, and CPU# undriven. If Bit 6 of Byte 0 is '1' then both CPU and CPU# are undriven. Note the example below shows CPU = 133 MHz and Bit 6 of Byte 0 = '0', this diagram and description is applicable for all valid CPU frequencies 66, 100, 133, 200 MHz.

Due to the state if the internal logic, stopping and holding the REF clock outputs in the LOW state may require more than one clock cycle to complete.

Power Down Assertion of Waveforms



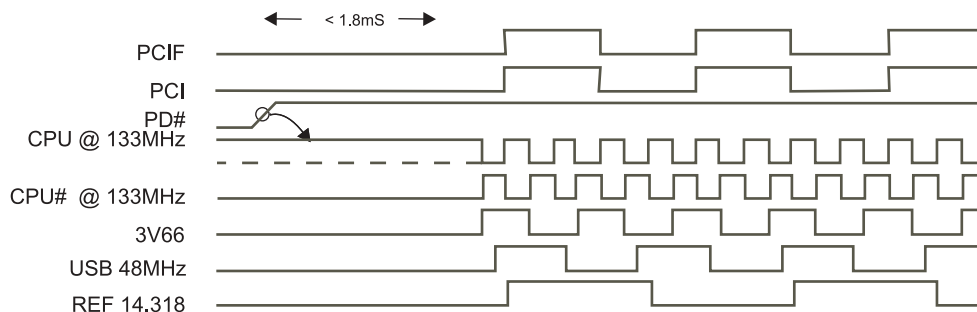
PD# Functionality

PD#	CPUCLKT	CPUCLKC	3V66	PCICLK_F PCICLK	USB/DOT 48MHz
1	Normal	Normal	66MHz	33MHz	48MHz
0	iref * Mult	Float	Low	Low	Low

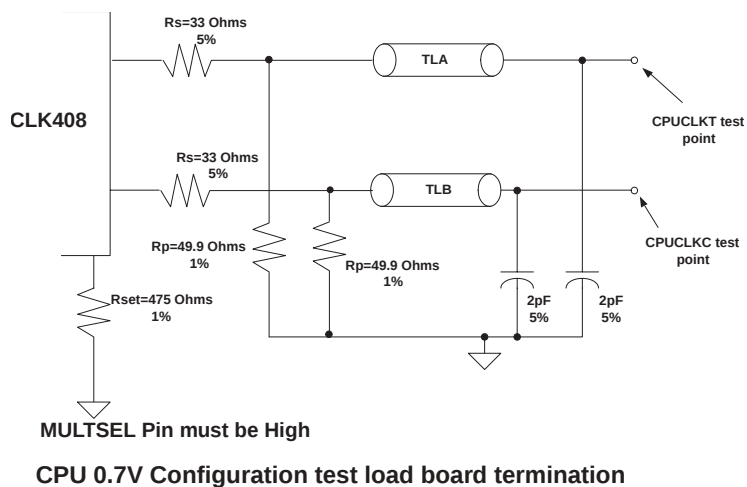


Power Down De-Assertion Mode

The power-up latency needs to be less than 1.8mS. this is the time from the de-assertion of the powerdown of the ramping of the power supply until the time that stable clocks are output from the clock chip. If the SMBus Bit 6 of Byte 0 is programmed to "1" then the stopped CPU outputs will be driven high within 3 nS of PD# de-assertion.



Test Configuration Diagram





Shared Pin Operation - Input/Output Pins

The I/O pins designated by (input/output) serve as dual signal functions to the device. During initial power-up, they act as input pins. The logic level (voltage) that is present on these pins at this time is read and stored into a 5-bit internal data latch. At the end of Power-On reset, (see AC characteristics for timing values), the device changes the mode of operations for these pins to an output function. In this mode the pins produce the specified buffered clocks to external loads.

To program (load) the internal configuration register for these pins, a resistor is connected to either the VDD (logic 1) power supply or the GND (logic 0) voltage potential. A 10 Kilohm (10K) resistor is used to provide both the solid CMOS programming voltage needed during the power-up programming period and to provide an insignificant load on the output clock during the subsequent operating period.

Figure 1 shows a means of implementing this function when a switch or 2 pin header is used. With no jumper is installed the pin will be pulled high. With the jumper in place the pin will be pulled low. If programmability is not necessary, than only a single resistor is necessary. The programming resistors should be located close to the series termination resistor to minimize the current loop area. It is more important to locate the series termination resistor close to the driver than the programming resistor.

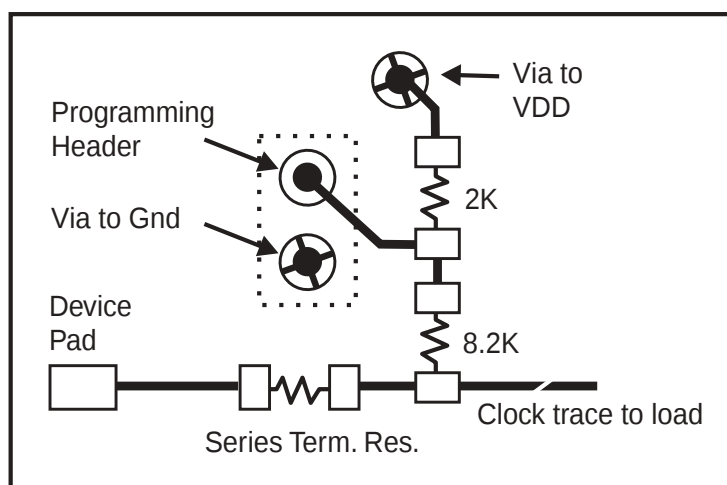
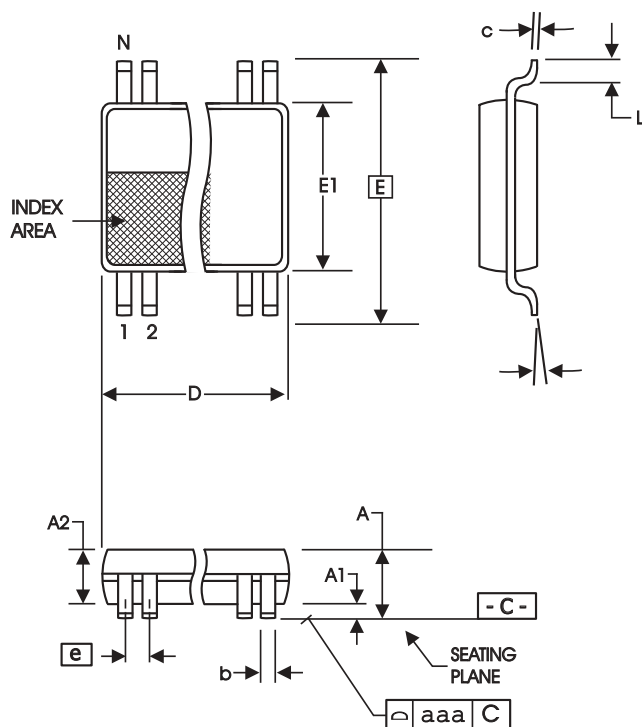


Fig. 1



6.10 mm. Body, 0.50 mm. pitch TSSOP
(240 mil) (20 mil)

6.10 mm. Body, 0.50 mm. Pitch TSSOP
(240 mil) (20 mil)

SYMBOL	In Millimeters		In Inches	
	COMMON DIMENSIONS		COMMON DIMENSIONS	
	MIN	MAX	MIN	MAX
A	--	1.20	--	.047
A1	0.05	0.15	.002	.006
A2	0.80	1.05	.032	.041
b	0.17	0.27	.007	.011
c	0.09	0.20	.0035	.008
D	SEE VARIATIONS		SEE VARIATIONS	
E	8.10 BASIC		0.319 BASIC	
E1	6.00	6.20	.236	.244
e	0.50 BASIC		0.020 BASIC	
L	0.45	0.75	.018	.030
N	SEE VARIATIONS		SEE VARIATIONS	
a	0°	8°	0°	8°
aaa	--	0.10	--	.004

VARIATIONS

N	D mm.		D (inch)	
	MIN	MAX	MIN	MAX
48	12.40	12.60	.488	.496

Reference Doc.: JEDEC Publication 95, MO-153

10-0039

Ordering Information

ICS950818yGT

Example:

ICS95 XXXX y G - T

Designation for tape and reel packaging

Package Type

G=TSSOP

Revision Designator (will not correlate with datasheet revision)

Device Type

Prefix

ICS, AV = Standard Device